

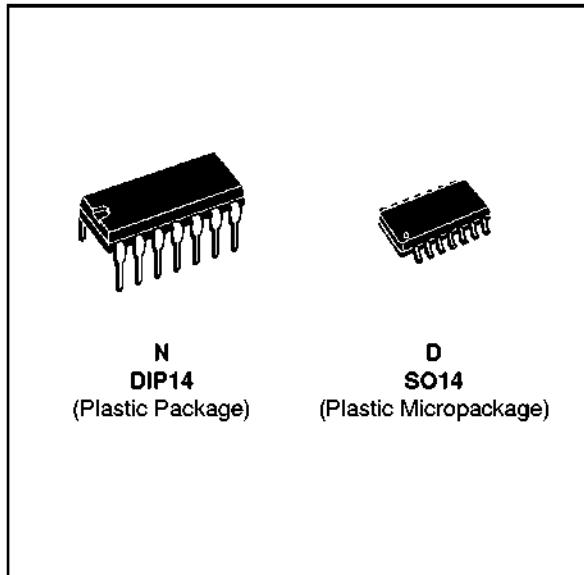


SGS-THOMSON
MICROELECTRONICS

MC33174 - MC35174

**LOW POWER
QUAD BIPOLEAR OPERATIONAL AMPLIFIERS**

- GOOD CONSUMPTION/SPEED RATIO : ONLY 200 μ A/Amp FOR 2.1MHz, 2V/ μ s
- SINGLE (OR DUAL) SUPPLY OPERATION FROM +4V TO +44V (\pm 2V TO \pm 22V)
- WIDE INPUT COMMON MODE VOLTAGE RANGE INCLUDING V_{CC}
- LOW LEVEL OUTPUT VOLTAGE CLOSE TO V_{CC} : 100mV TYPICAL
- PIN TO PIN COMPATIBLE WITH STANDARD QUAD OP AMPS
- ESD PROTECTION



DESCRIPTION

The MC33174 series are quad bipolar operational amplifiers offering both low consumption (200 μ A/Amp) and good speed (2.1MHz, 2V/ μ s).

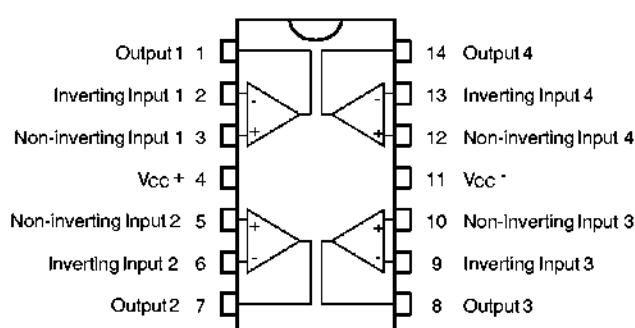
Moreover the Input Common Mode Range extends down to the lower supply rail, allowing single supply operation from +4V to +44V.

ORDER CODES

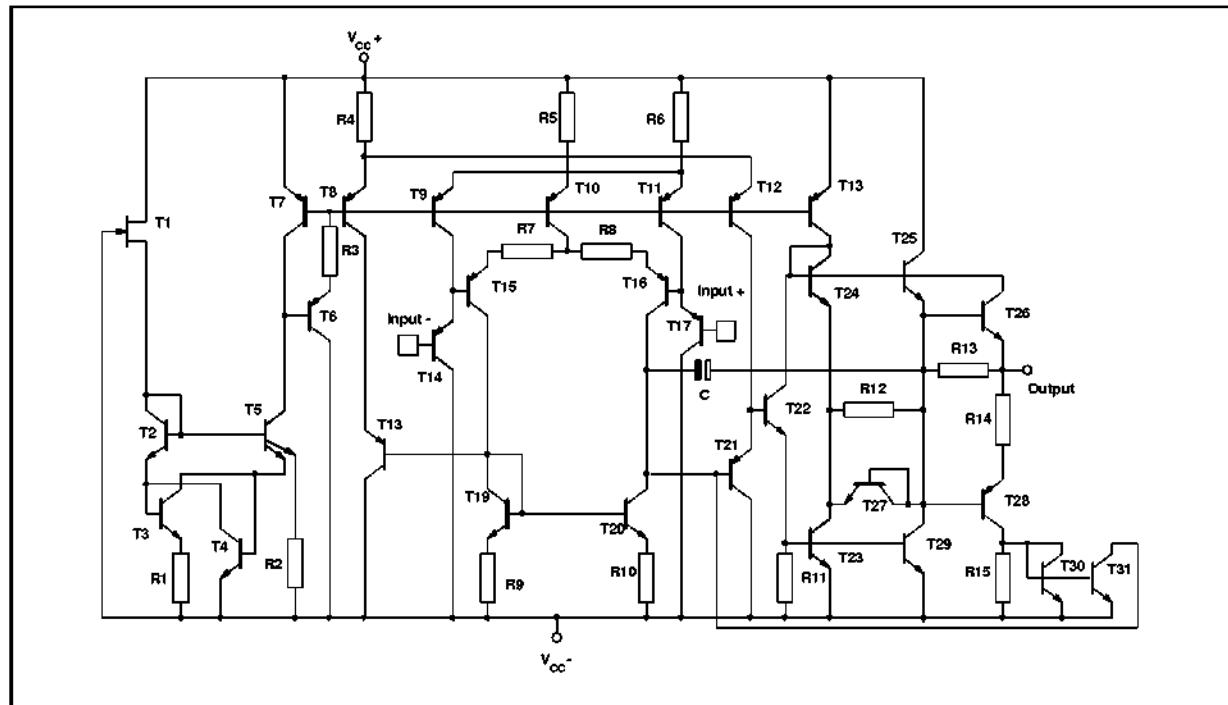
Part Number	Temperature Range	Package	
		N	D
MC33174	-40°C, +105°C	•	•
MC35174	-55°C, +125°C	•	•

Example: MC33174N

PIN CONNECTIONS (top view)



SCHEMATIC DIAGRAM (for 1/4 MC33174)



ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V _{CC}	Supply Voltage	+22	V
V _{id}	Differential Input Voltage	(Note 1)	V
V _i	Input Voltage	(Note 1)	V
	Output Short Circuit Duration	Indefinite	s
T _{oper}	Operating Temperature Range MC33174 MC35174	-40 to 105 -55 to 125	°C
T _j	Junction Temperature	150	°C
T _{stg}	Storage Temperature	-65 to 150	°C

Note 1: Either or both input voltages must not exceed the magnitude of V_{cc}.

OPERATING CONDITIONS

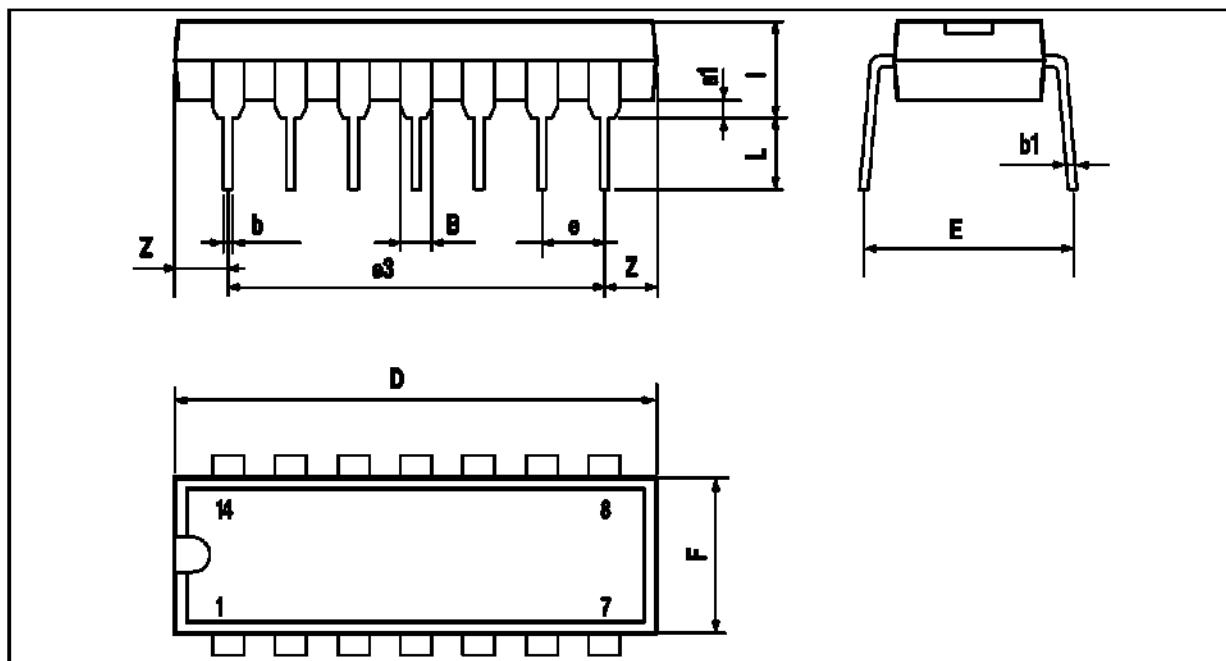
Symbol	Parameter	Value	Unit
V _{CC}	Supply Voltage Range	±2 to ±22	V

ELECTRICAL CHARACTERISTICS $V_{CC^+} = +15V, V_{CC^-} = -15V, R_L$ connected to Ground, $T_{amb} = 25^\circ C$ (unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Unit
V_{IO}	Input Offset Voltage $V_{CC^+} = +15V, V_{CC^-} = -15V, V_{IC} = 0V$ $V_{CC^+} = 5V, V_{CC^-} = 0V, V_{IC} = 0V, V_o = 1.4V$ $V_{CC^+} = +15V, V_{CC^-} = -15V, V_{IO} = 0V, T_{min.} \leq T_{amb} \leq T_{max.}$		1 1	4.5 5 6.5	mV
DV_{IO}	Input Offset Voltage Drift		10		$\mu V^\circ C$
I_{IO}	Input Offset Current ($V_{IC} = 0V$) $T_{min.} \leq T_{amb} \leq T_{max.}$		5 40	20	nA
I_{IB}	Input Bias Current ($V_{IC} = 0V$) $T_{min.} \leq T_{amb} \leq T_{max.}$		20	100 200	nA
A_{vd}	Large Signal Voltage Gain ($R_L = 10k\Omega, V_O = \pm 10V$) $T_{min.} \leq T_{amb} \leq T_{max.}$	50 25	100		V/mV
V_{OH}	High Level Output Voltage $V_{CC^+} = 5V, V_{CC^-} = 0V, R_L = 10k\Omega$ $V_{CC^+} = +15V, V_{CC^-} = -15V, R_L = 10k\Omega$ $V_{CC^+} = +15V, V_{CC^-} = -15V, R_L = 10k\Omega, T_{min.} \leq T_{amb} \leq T_{max.}$	3.5 13.6 13.3	4.2 14.2		V
V_{OL}	Low Level Output Voltage $V_{CC^+} = 5V, V_{CC^-} = 0V, R_L = 10k\Omega$ $V_{CC^+} = +15V, V_{CC^-} = -15V, R_L = 10k\Omega$ $V_{CC^+} = +15V, V_{CC^-} = -15V, R_L = 10k\Omega, T_{min.} \leq T_{amb} \leq T_{max.}$		0.1 -14	0.15 -13.6 -13.3	V
I_{SC}	Output Short Circuit Current ($V_{ID} = \pm 1V, V_O = 0V$) Source Sink	3 15	6 27		mA
V_{ICM}	Input Common Mode Voltage Range $T_{min.} \leq T_{amb} \leq T_{max.}$	V_{CC^-} to ($V_{CC^+} - 1.8$) V_{CC^-} to ($V_{CC^+} - 2.2$)			V
CMR	Common Mode Rejection Ratio ($V_i = V_{ICM\ min.}$)	80	100		dB
SVR	Supply Voltage Rejection Ratio ($V_{CC} = \pm 5$ to $\pm 15V$)	80	100		dB
I_{CC}	Supply Current (per amplifier) $V_{CC^+} = 5V, V_{CC^-} = 0V$, no load $V_{CC^+} = +15V, V_{CC^-} = -15V$, no load $V_{CC^+} = +15V, V_{CC^-} = -15V$, no load, $T_{min.} \leq T_{amb} \leq T_{max.}$		200 220	250 250 300	μA
SR	Slew Rate ($V_i = \pm 10V, R_L = 10k\Omega, C_L = 100pF$)	1.6	2		V/ μs
GBP	Gain Bandwidth Product ($R_L = 10k\Omega, C_L = 100pF, f = 100kHz$)	1.4	2.1		MHz
ϕ_m	Phase Margin ($R_L = 10k\Omega, C_L = 100pF$)		45		Degrees
e_n	Equivalent Input Noise Voltage ($f = 1kHz$)		29		$\frac{nV}{\sqrt{Hz}}$
THD	Total Harmonic Distortion		0.05		%
V_{O1}/V_{O2}	Channel Separation		120		dB

MC33174 - 35174

PACKAGE MECHANICAL DATA
14 PINS - PLASTIC DIP



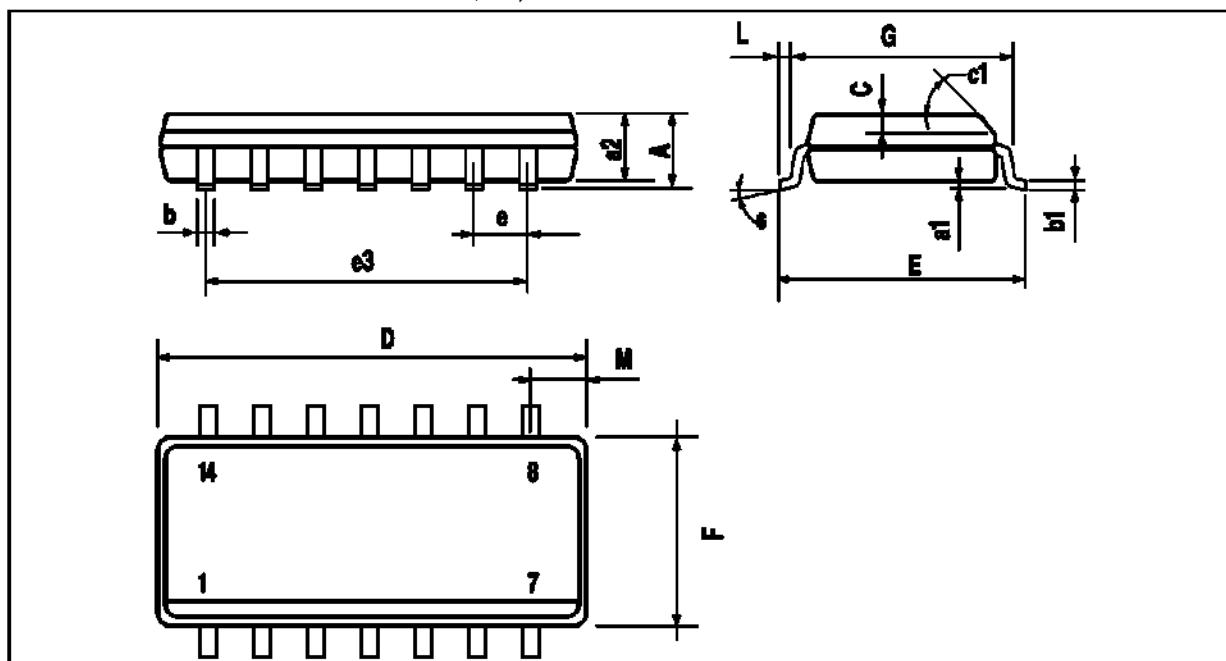
DIP-14-TBL

Dimensions	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
a1	0.51			0.020		
B	1.39		1.65	0.055		0.065
b		0.5			0.020	
b1		0.25			0.010	
D			20			0.787
E		8.5			0.335	
e		2.54			0.100	
e3		15.24			0.600	
F			7.1			0.280
i			5.1			0.201
L		3.3			0.130	
Z	1.27		2.54	0.050		0.100

DIP-14-TBL

PACKAGE MECHANICAL DATA

14 PINS - PLASTIC MICROPACKAGE (SO)



PM-DIP14.EPS

S014 TBL

Dimensions	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.75			0.069
a1	0.1		0.2	0.004		0.008
a2			1.6			0.063
b	0.35		0.46	0.014		0.018
b1	0.19		0.25	0.007		0.010
C		0.5			0.020	
c1	45° (typ.)					
D	8.55		8.75	0.336		0.334
E	5.8		6.2	0.228		0.244
e		1.27			0.050	
e3		7.62			0.300	
F	3.8		4.0	0.150		0.157
G	4.6		5.3	0.181		0.208
L	0.5		1.27	0.020		0.050
M			0.68			0.027
S	8° (max.)					

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